0 STA	ABLCOR®
ST10-LC909-0.009	TYPICAL ENGINEERING VALUES

ST10-LC909-0.009	TYPICAL ENGINEERING VALUES				
Property / Condition	Sample Thickness	Value (U.S. Units)	Value (Metric Units)	Test Method	
Mechanical					
Peel Strength - Standard profile 1 oz. copper					
a. After Thermal Stress (Solder Float)		4.0 lb/inch minimum	.72N/mm minimum	IPC-TM-650.2.4.8	
b. At 170C (338F) temp.	.20 mm	4.0 lb/inch minimum	.72N/mm minimum	IPC-TM-650.2.4.8 / 2.4.8.2 / 2.4.8.3	
b. At 125C (257F) temp.	(0.008 in)	4.0 lb/inch minimum	.72N/mm minimum	IPC-TM-650.2.4.8 / 2.4.8.2 / 2.4.8.	
c. After process solutions		4.0 lb/inch minimum	.72N/mm minimum	IPC-TM-650.2.4.8	
X - CTE	0.61 mm	1 - 5 ppm/C		Surface Strain Gauge	
Y - CTE	(0.024 in)	1 - 5 ppm/C		Surface Strain Gauge	
Z - CTE					
Below Glass Transition	0.61 mm	35 - 65 ppm/C		IPC-TM-650.2.4.24	
Above Glass Transition	(0.024 in)	150 - 250 ppm/C		IPC-TM-650.2.4.24	
Flexural Strength			2	1	
a. Lengthwise Direction	0.56 mm	75kpsi minimum	500 N/mm <sup>2</sup> minimum		
b. Crosswise Direction	(0.022 in)	75kpsi minimum	500 N/mm <sup>2</sup> minimum	IPC-TM-650-2.4.4	
Thermal					
Glass Transition Temperature					
by DSC	0.61 mm (0.024 in)	260°C		IPC-TM-650,2,4,25c	
by 200	0.61 mm	260°C		II O TW 000.2.4.200	
by TMA	(0.024 in)	250°C		IPC-TM-650.2.4.25c	
	0.61 mm			1	
Decomposition Temperature (Td) at 5% Wt. loss	(0.024 in)			ASTM D3850	
	.61 mm			1	
Pressure Vessel	(0.024 in)	Level 4		IPC-TM-650.2.6.16	
Chemical / Physical					
Chemical / Physical	.20 mm			T	
Chemical Resistance	(0.008 in)	0.29%		IPC-TM-650.2.3.4.3	
Density (g/cc)	.20 mm				
	(0.008 in)	1.6		TBD	
Flammability	.20 mm (0.008 in)	94V-0		UL94	
Outgassing (CVCM<0.1% and TML<=1.0%)	.61 mm	CVCM=0.011%, TML=0.205%		ASTM E-595-93	
Water Vapor Regain (%WVR)	(0.024 in)	0.16%		ASTM E-595-93	
Electrical					
Volume Resistivity (UnClad Samples)	00			I	
After 48hrs Laboratory Conditions (23C/50%RH)	.20 mm (0.008 in)	3.54E+09 MegOhms-cm		IPC-TM-650.2.5.17.1	
After Temperature/Humidity (35C/90%RH)	(0.008 111)	2.81E+09 MegOhms-cm		IPC-TM-650.2.5.17.1	
Surface Resistivity (UnClad Samples)	<del></del>			I	
After 48hrs Laboratory Conditions (23C/50%RH)	.20 mm	2.65E+08 MegOhms		IPC-TM-650.2.5.17.1	
After Temperature/Humidity (35C/90%RH)	(0.008 in)	1.89E+07 MegOhms		IPC-TM-650.2.5.17.1	
Electric Strength	0.61 mm	n/a		IPC-TM-650.2.5.6.2; ASTM-D-149	
Dielectric Breakdown	(0.024 in)	n/a		ASTM-D-299	
Permittivity at 1Mhz, maximum		n/a		IPC-TM-650.2.5.5.2	
Thermal Stress, 10 seconds at 288°C				1	
A. Unetched	0.61 mm	PASS		IPC-TM-650.2.4.13.1	
B. Etched	(0.024 in)	PASS		IPC-TM-650.2.4.13.1	
STANDARD Core THICKNESS	STANI	DARD PANEL SIZE	STANDAR	D COPPER CLADDING	
ST10-LC909:	STATISTICS TARREST SIZE		STANDARD COLL EK CEADDING		
0.009" (0.229mm)	18" X 24" (457	7 X 610 mm)	1/2 OZ. (17uM) Electrodeposited Copper Foil		
· · · · · · /	,		1.0 OZ. (35uM) Electrodeposited Copper Foil		

1.0 OZ. (35uM) Electrodeposited Copper Foil

The Information provided in this data sheet represents general typical values obtained under certain test conditions and is not a specific representations of values for any specific or intended application. The value provided does not constitute a warranty or guarantee of performance of Stablcor® in a particular application or that the results shown on this data sheet will be achieved by a user for a particular purpose. The user should determine the suitability of STABLCOR material for each application. Carbon Core Laminates reserves the right to amend and change the general typical values provided based on different testing conditions and /or techniques. Carbon Core Laminates can be contacted at Ph: (508) 581-2198. To obtain detailed validation results, please send inquires to Engineering@stablcor.com

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